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In re Application of:

Junichi HIKITA

Application No.:

10/626,524

Filing Date:

July 25, 2003

Title: METHOD OF PRODUCING A SEMICONDUCTOR DEVICE BY DIVIDING
A SEMICONDUCTOR WAFER INTO SEPARATE PIECES OF SEMICONDUCTOR
CHIPS (as amended)

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October 17, 2005
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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/626,524 ✓	09/15/2005			1133
			EXAMINER	
			ART UNIT	PAPER NUMBER

DATE MAILED: 09/15/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

RECEIPT NO. 21766 DATE: July 22, 2005
ATTY. DOCKET: AI 290 D1

APPLICANT: Junichi HIKITA

SERIAL NO.: Divisional of 09/704,563

FILED: July 25, 2003

**FOR: METHOD OF PRODUCING A SEMICONDUCTOR
DEVICE BY DIVIDING A SEMICONDUCTOR WAFER
INTO SEPARATE PIECES OF SEMICONDUCTOR CHIPS
(AS AMENDED)**

PAPERS FILED:

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FEE: \$0.00

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RECEIPT NO. 21766 — DATE: July 22, 2005

ATTY. DOCKET: AI 290 D1

APPLICANT: Junichi HIKITA

SERIAL NO.: Divisional of 09/704,563

FILED: July 25, 2003

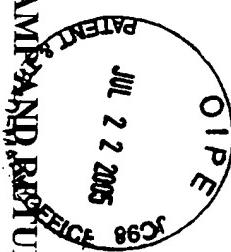
FOR: METHOD OF PRODUCING A SEMICONDUCTOR
DEVICE BY DIVIDING A SEMICONDUCTOR WAFER
INTO SEPARATE PIECES OF SEMICONDUCTOR CHIPS
(AS AMENDED)

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RECEIPT NO. *20079* **DATE:** *February 8,
2005*
ATTY. *AI 290 D1*
DOCKET:

APPLICANT(S): Junichi HIKITA
SERIAL NO.: Divisional of 09/704,563
FILED: July 25, 2003
FOR: METHOD OF PRODUCING A SEMICONDUCTOR
DEVICE BY DIVIDING A SEMICONDUCTOR WAGER
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(AS AMENDED)
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AI 290 D1

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ATTN DOCKET NO.: RCV-0031/DIV
(80246-0072)

Inventor: Junichi HIKITA, et al.

Application No.: Not Yet Assigned Filing Date: July 24, 2003

Title: METHOD OF PRODUCING A SEMICONDUCTOR DEVICE BY DIVIDING A
SEMICONDUCTOR WAFER INTO SEPARATE PIECES OF SEMICONDUCTOR CHIPS
(AS AMENDED)

Documents Filed:

Transmittal-New Utility Patent Application (in duplicate) Preliminary Amendment

Fee Transmittal (in duplicate) Information Disclosure Statement

Specification (44 pages) Form PTO/SB/08A

Drawings (10 sheets)

Copy of Oath or declaration

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MAIL STOP PATENT APPLICATION

Sender's Initials: YY/CS/ddd

Date filed in the USPTO: July 24, 2003

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